

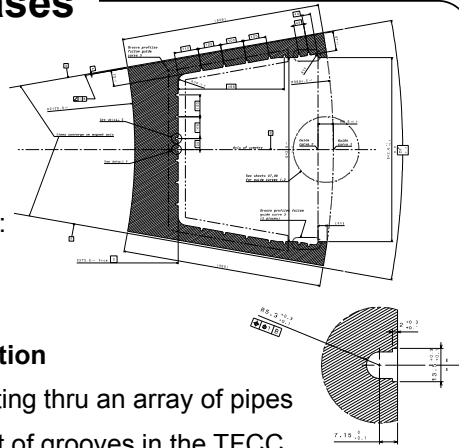
Measurements of the Effective Thermal Conductivity of the ITER TF Coil Case Cooling System

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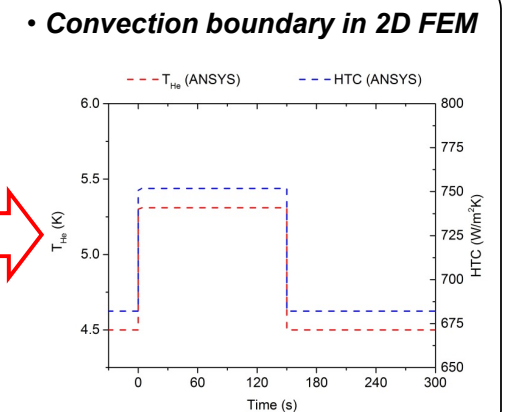
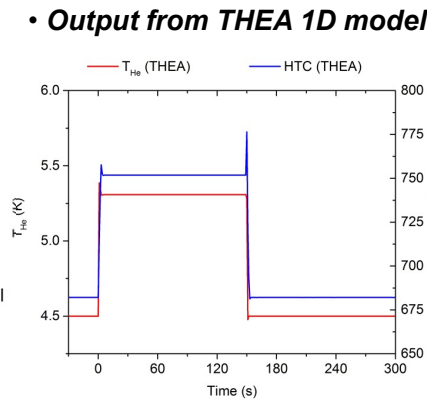
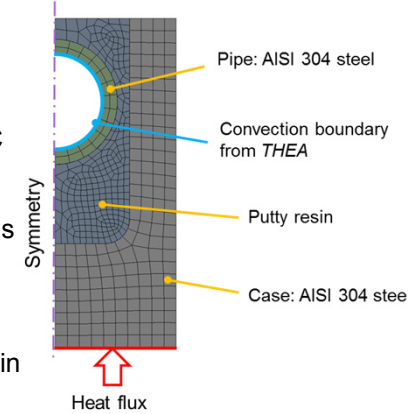
ITER Toroidal Field Coil Cases

- Each ITER TF winding pack is enclosed in a thick stainless steel case:
 - Provides **mechanical support**
 - Also acts as a **thermal screen**
- During operation, the coil case is subjected to:
 - Eddy current heating**
 - Nuclear heating**
 - Static heat loads: **conduction and radiation**
- The TFCCs are cooled by **He at 4.5 K** circulating thru an array of pipes
- The **cooling pipes** are **resin-bonded** to a set of grooves in the TFCC



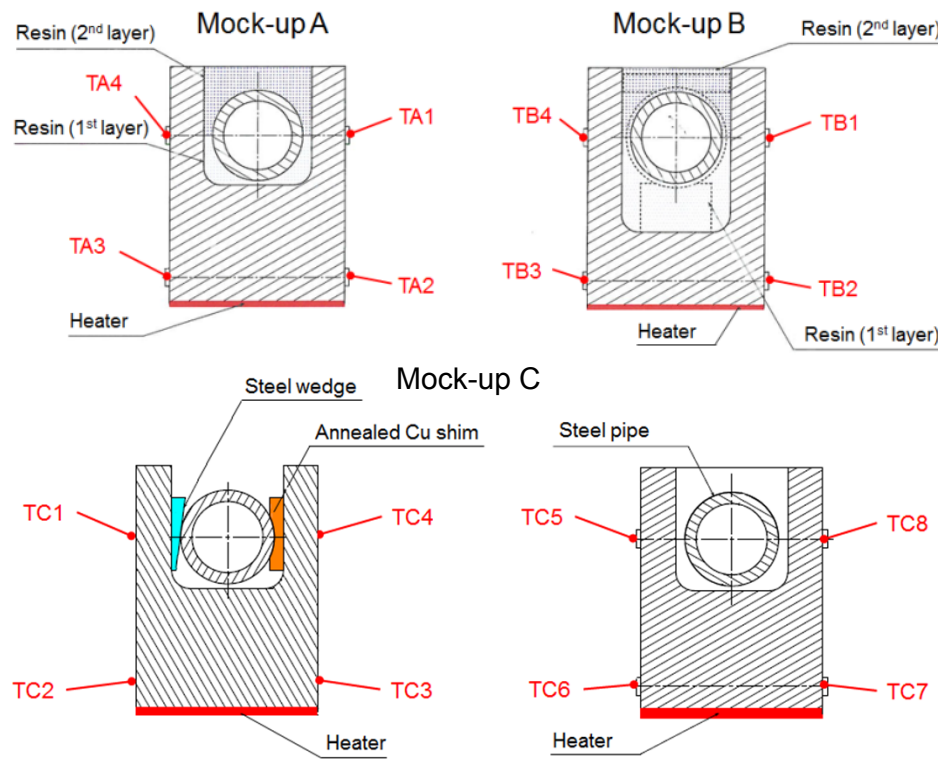
Finite Element Model

- Heat load** applied at the bottom
- Boundary condition in the pipe imported from a **1D thermal-hydraulic model in THEA**
 - Dittus-Bölder correlation for computing HTC
- All **other boundaries** are assumed **adiabatic**
- Thermal properties of the putty**: 3 assumptions
 - "Epoxy-like" putty
 - "Stainless-steel" putty
 - Measurements of wollastonite-charged resin from KIT



TFCC Mock-up samples

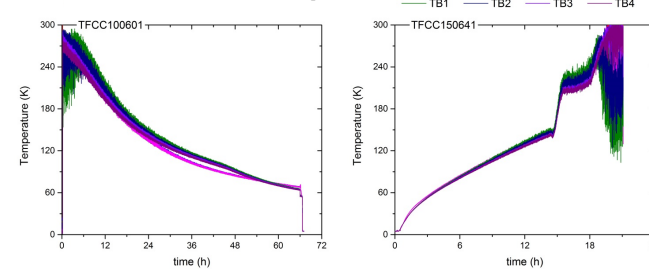
- Mock-ups A and B** explore the effective thermal conductivity in the **baseline design**: thermal contact given by **wollastonite-charged putty**
- In **mock-up C** the thermal path is provided by 6 pairs of **stainless steel and copper shims**
- A **heater** is installed in each **mock-up**
- Cernox sensors** (range 4 to 325 K) are used to measure the temperature
- Mock-up B** was also tested after a four point bending at room temperature



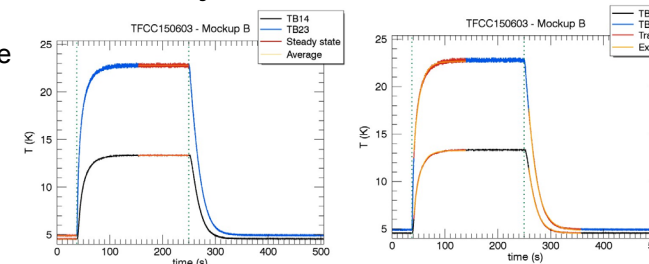
Experimental measurements

- Care to **avoid thermal shock** to the samples
- No signs of cracks or delamination** affecting the contact conductivity

Cool-down and warm-up

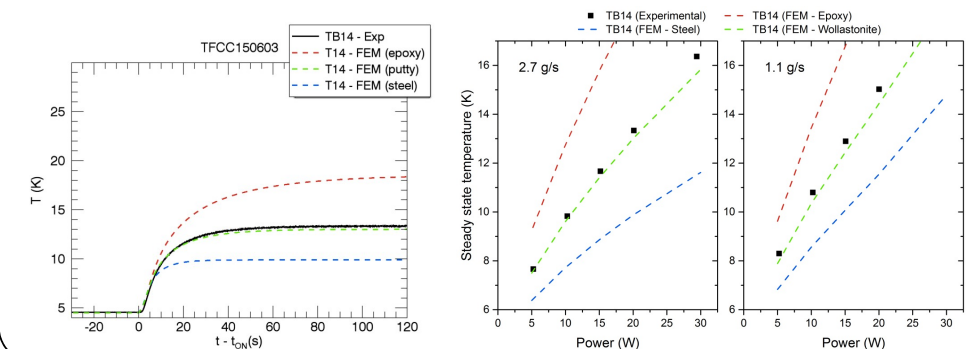


Data analysis



Comparison with simulations

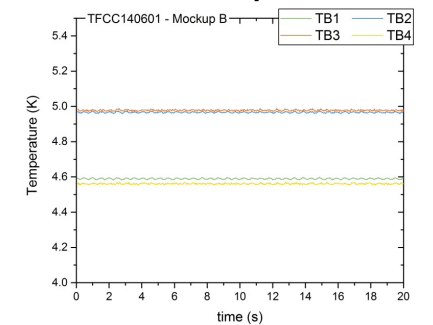
- The FEM assuming the prop of wollastonite-charged resin accurately predicts T



Temperature gradient with no intentional heat input

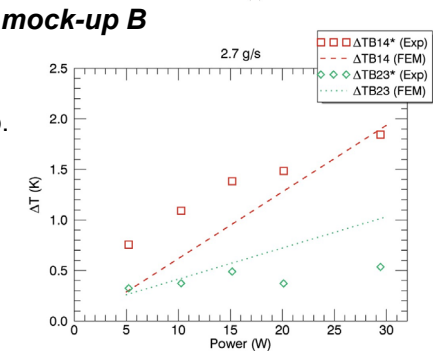
- A **small temperature gradient** observed even when **no intentional heat** is applied
- The **offset can be corrected** during post-processing:

$$T^* = T_{heat\ ON} - (T_{heat\ OFF} - T_{He\ IN})$$



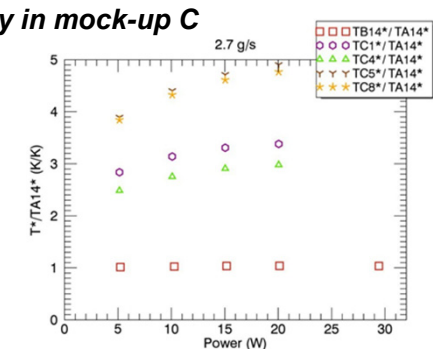
Effect of bending mock-up B

- A **small increase ΔT** observed after a **four point bending** process at room temp.
- ΔT is comparable to that observed if the **contact conduction** between resin and steel case is **limited to ~380 W/m²·K** in the FEM



Effective conductivity in mock-up C

- The conductivity in mock-up C is **dominated by the poor contact** between the **metallic shims** and the **cooling pipe**
- TC1* and TC4* are **~3× higher** than TA14*
- The time evolution is **15 to 50 times slower** compared to mock-ups A and B



Experimental set-up

- The samples were tested in **SULTAN** (hanging from the 100 kA trafo)
- A constant flow of **He at 10 bar and 4.5 K** circulates through the pipes (1.1 to 2.7 g/s)
- A **steady state heat load** is applied in the sample heater (5 to 30 W)
- The **effective thermal conductivity** is evaluated by comparing the **measured temperature distribution** with the **predictions** from a **finite element model**

Conclusions

- The model assuming the thermal conductivity of a **wollastonite-charged resin predicts quite well the temperature distribution**
- No indication of cracks or delamination** decreasing significantly the overall heat conductivity of the mock-ups **after cool-down**

- A **four point bending process** introduces a small contact resistance, but it **does not compromise the overall heat conductivity**
- An **alternative design** relying exclusively in the **contact between metallic shims** and the cooling pipe is **not as effective as the baseline design**